



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



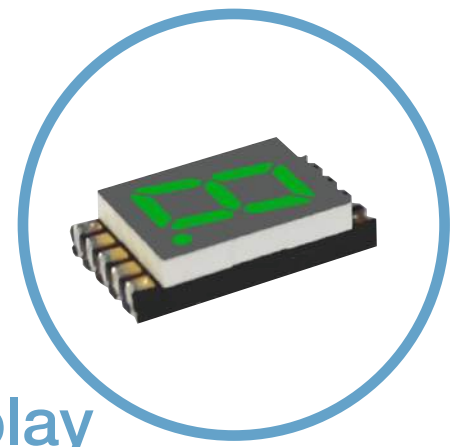
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DSM Series Ultra Thin Surface Mount Single Digit 7-Segment LED Display

DSM7UA30105 - 0.30" (7.62mm) Digit Height
Emitting Color: Pure Green (InGaN/GaN)

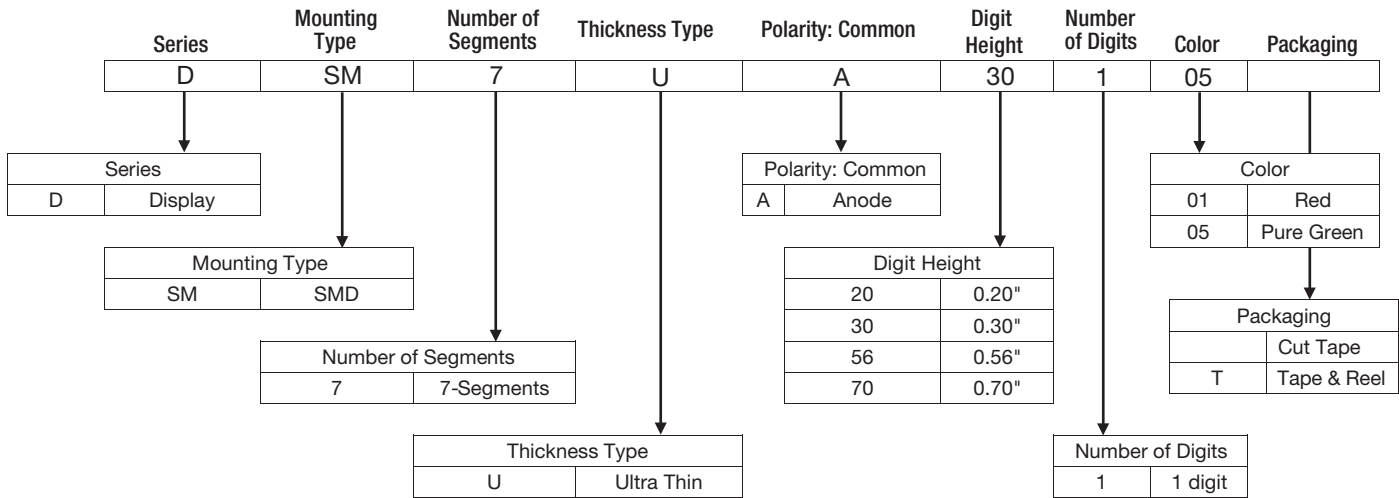
Applications

- People Movers
- Home Appliances
- Medical Devices
- Industrial Devices
- Automation and Controls
- Light Control
- IoT
- Transportation
- Food Service Appliances

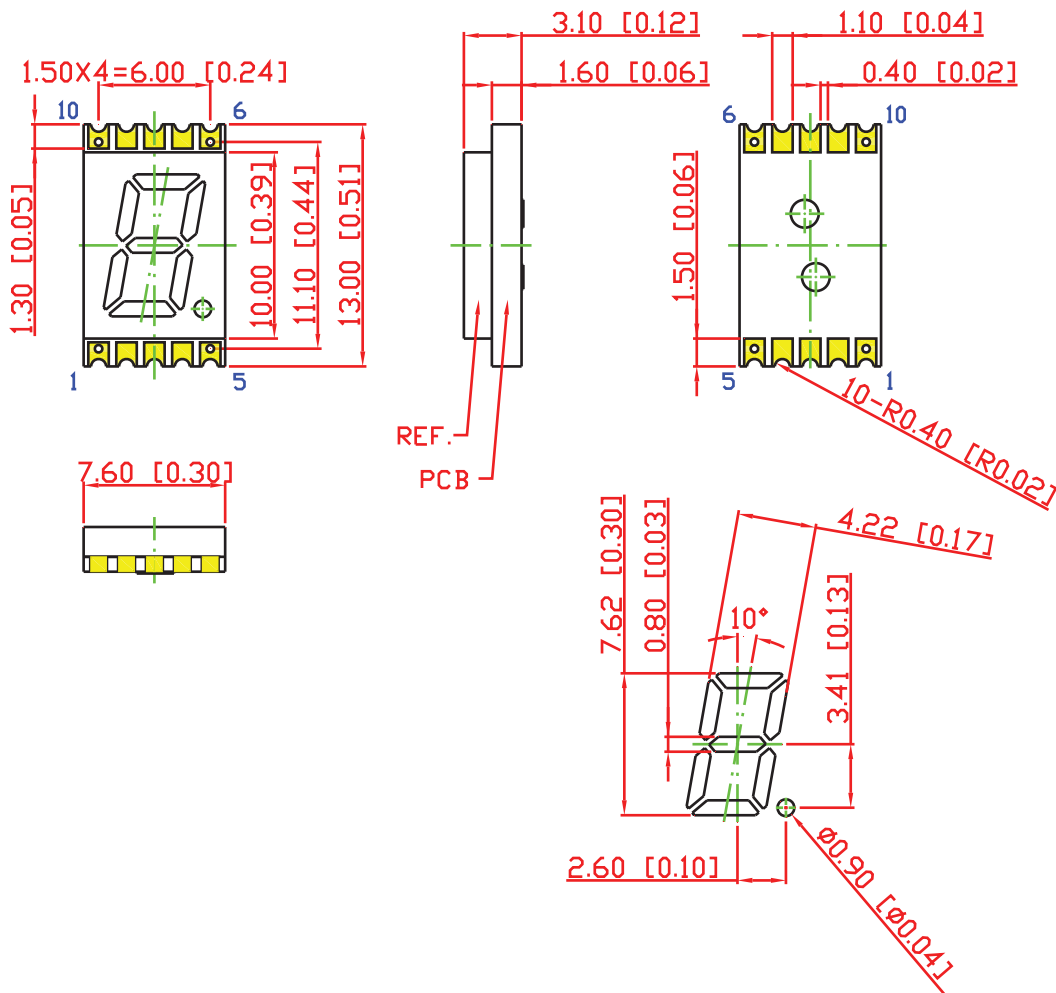
Key Features

- 1-digit seven segment led numeric display
- Outer dimensions: 13.0 X 7.60 X 3.10mm
- Reduce overall thickness of PCB, with major cost savings
- Available in 4 different digit heights and widths
- Excellent character appearance, with high light output
- Super green chip
- Made from InGaN on transparent GaN substrate
- Made of white segments and gray surface
- Also available in super bright red
- Available in cut tape or automation-friendly tape and reel
- Exclusive patented technology
- Low current operation and lower power consumption
- Polarity: common anode
- Available for reverse mounting configuration
- Side by side mounting allows space saving
- Easy mounting on PC boards or sockets
- Moisture Sensitive Level (MSL): 2a
- Life expectancy: 100,000 hours
- Technically and mechanically rugged
- Quality tested with the highest industry standard

Ordering Data



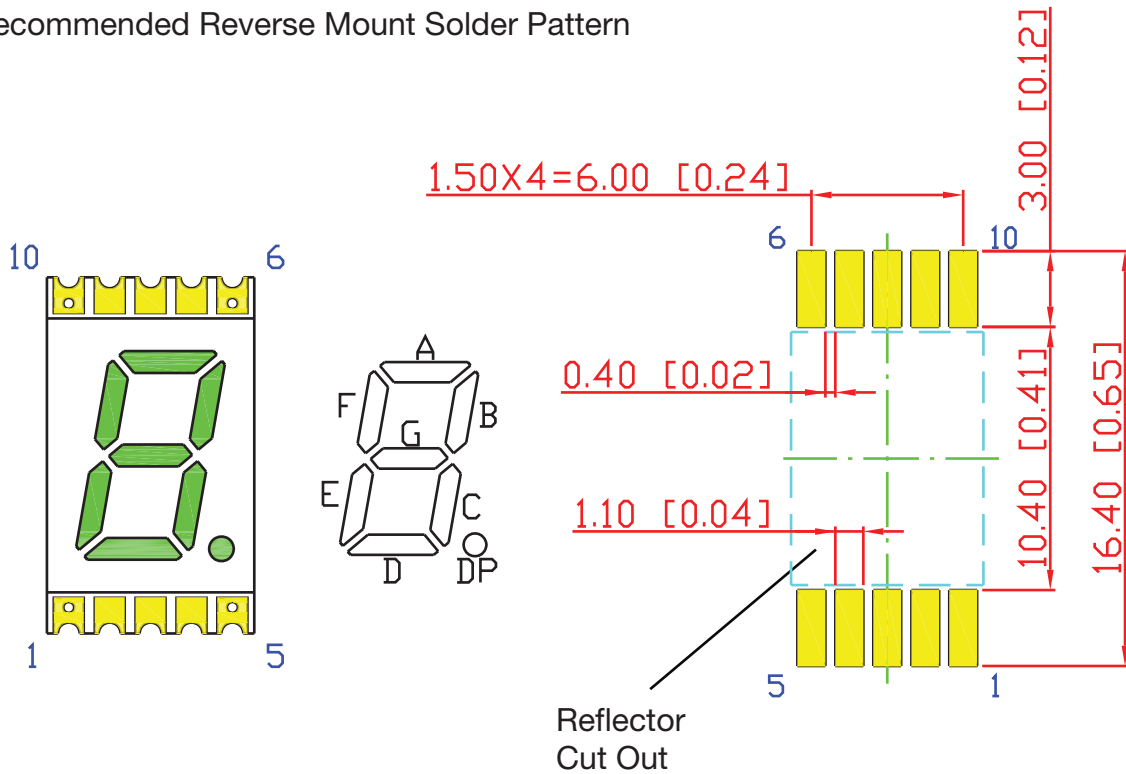
Dimensions and Internal Circuit Diagram



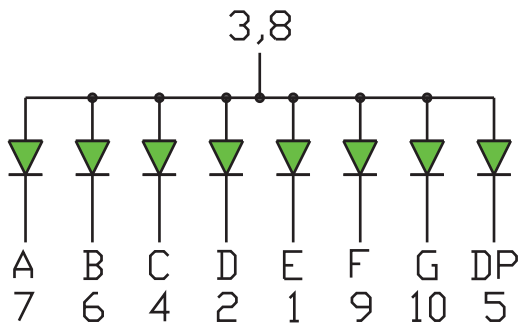
Tolerance is $\pm 0.25\text{mm}$ [0.01"] unless otherwise noted
 Dimensions in millimeters [inches]

Dimensions and Internal Circuit Diagram

Recommended Reverse Mount Solder Pattern



Pin Connections (Common Anode)



PIN No	Connection
1	CATHODE E
2	CATHODE D
3	COMMON ANODE
4	CATHODE C
5	CATHODE DP
6	CATHODE B
7	CATHODE A
8	COMMON ANODE
9	CATHODE F
10	CATHODE G

Product Specifications

Absolute Maximum Rating at Ta=25°C / 77°F (Ta= Ambient Temperature)

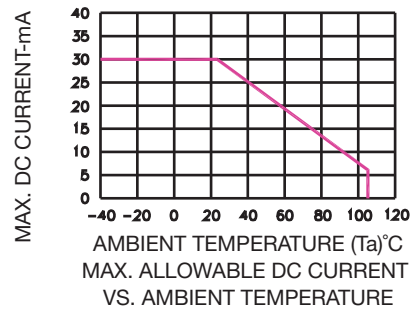
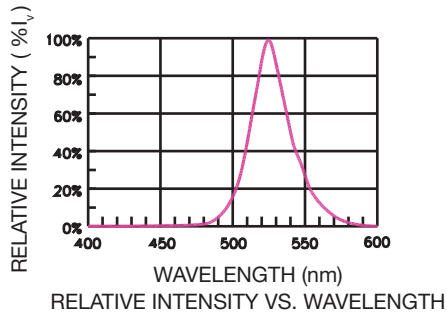
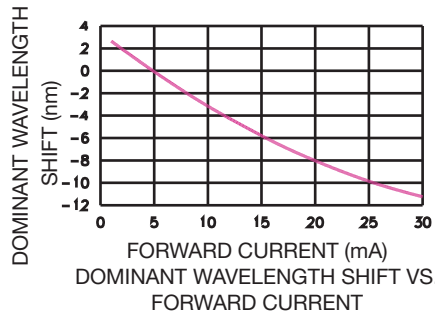
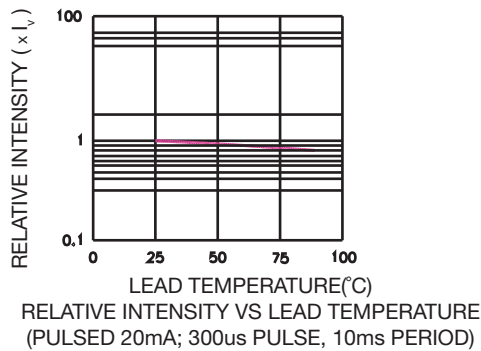
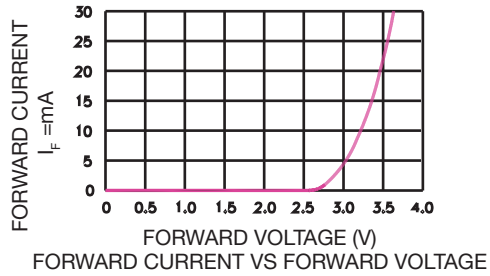
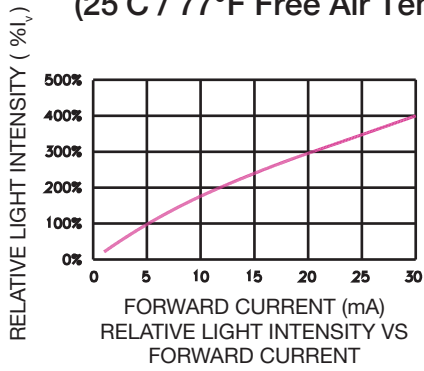
Parameter	Symbol	Maximum Rating	Unit
Power dissipation	P _{AD}	120	mW
Derating liner from 25°C/77°F	-	0.30/9.46	mA °C / °F
Continuous forward current	I _{AF}	30	mA
Peak current (duty cycle 1/10, 1kHz)	I _{PF}	100	mA
Reverse voltage	V _R	5	V
Operating temperature	T _{OPR}	-40 TO +105 -40 TO +221	°C °F
Storage temperature	T _{STG}	-40 TO +105 -40 TO +221	°C °F

Electrical - Optical Characteristics at Ta=25°C / 77°F (Ta= Ambient Temperature)

Charateristic	Symbol	Condition	Min.	Typ.	Max.	Unit
Forward Voltage, (Per Dice)	V _F	I _F =20mA	-	2.8	3.6	V
Reverse Current, (Per Dice)	I _R	V _R =8V	-	-	10	μA
Dominant Wavelength	λ _D	I _F =20mA	515	-	530	nm
Luminous Intensity	I _V	I _F =20mA	70	-	150	mcd
Spectral radiation bandwidth	Δλ	I _F =20mA	-	30	-	nm

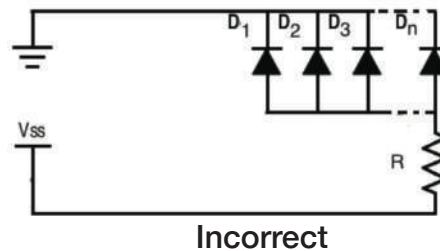
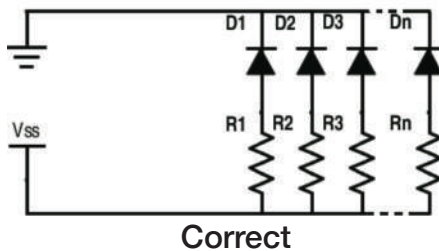
Product Specifications

Typical Electro-optical Characteristic Curves (25°C / 77°F Free Air Temperature Unless Otherwise Specified)



Circuit Design Notes

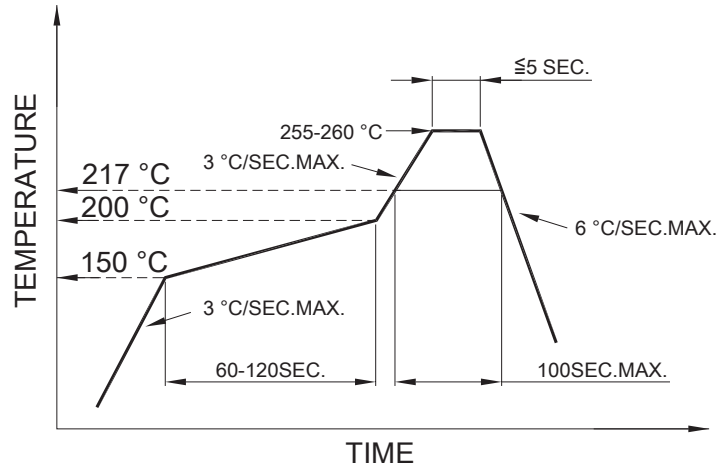
- Always use current limit resistors when necessary
- LEDs could be electrically connected in parallel, with each LED having its own current limiting resistor



Recommended Reflow Soldering Profile

- SMT Reflow Soldering Instructions

SMT Soldering Profile
Pb free reflow soldering Profile



- We recommend the reflow temperature 245°C / 473°F (+/- 5°C / 41°F). The maximum soldering temperature should be limited to 260°C / 500°F.
- Number of reflow process shall be 2 time or less.

- Soldering Iron

Basic spec is ≤ 4 sec when 260°C / 500°F. If temperature is higher, time should be shorter (+10°C / 50°F \rightarrow 1 sec). Power dissipation of Iron should be smaller than 15W, and temperature should be controllable. Surface temperature of the device should be under 230°C / 446°F.

- Rework

- Customer must finish rework within 3 sec. under 350°C / 662°F.
- The head of soldering iron cannot touch copper foil.

Storage Condition

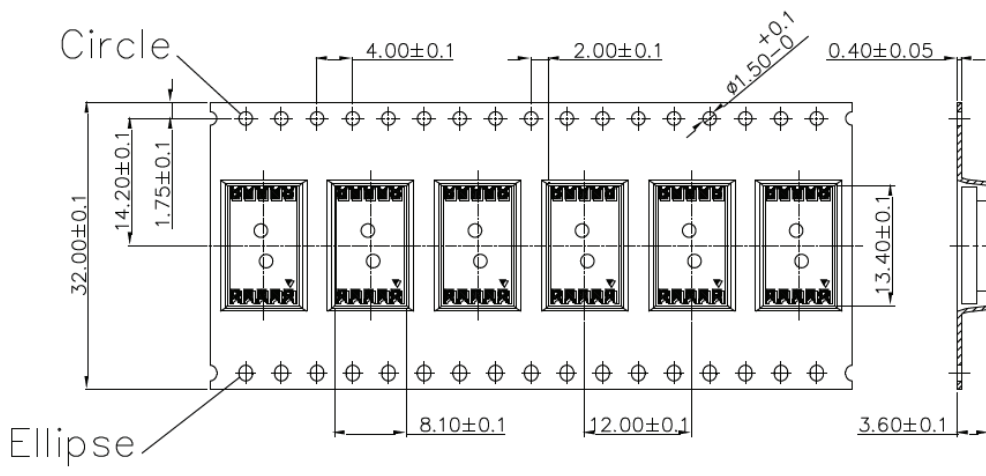
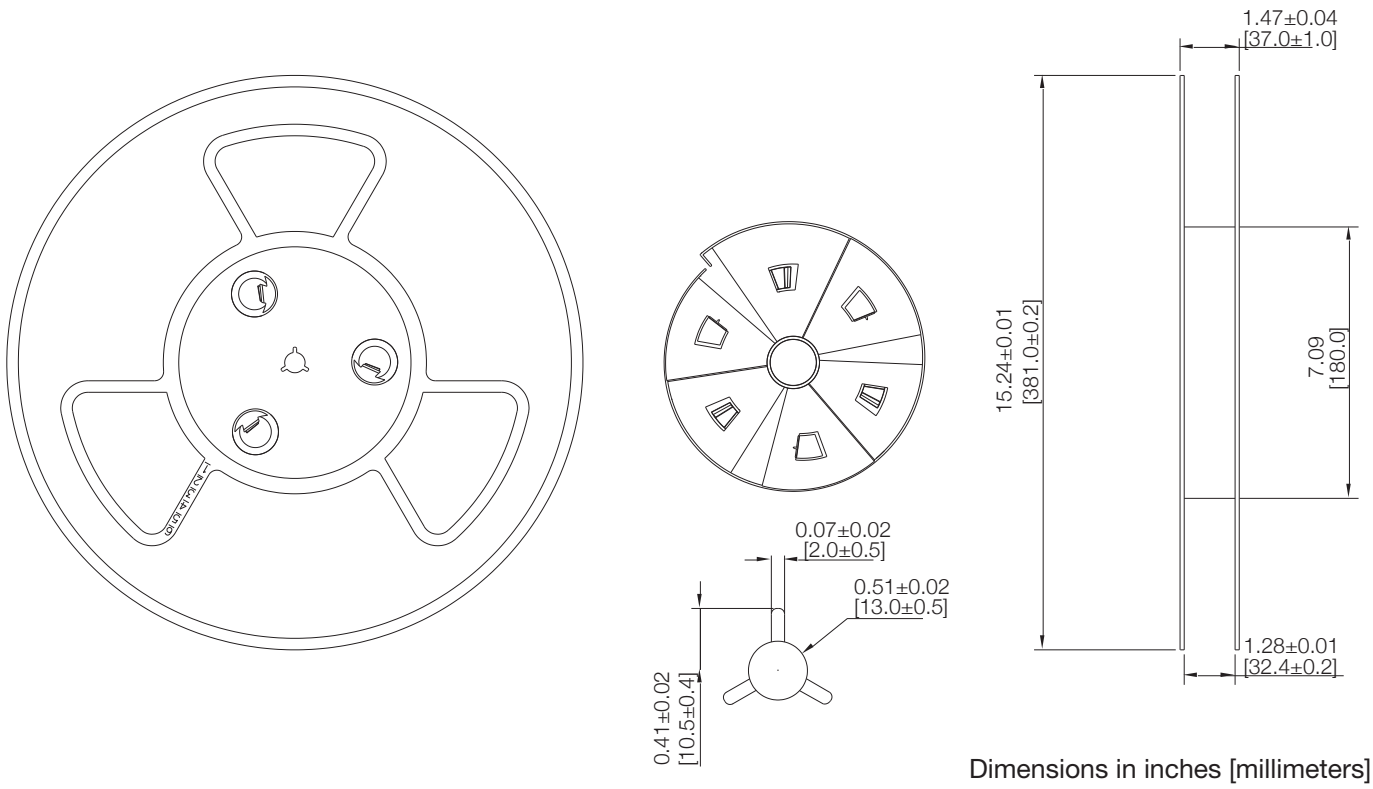
In factory original sealed bag package

TEMPERATURE CONDITION	HUMIDITY CONDITION
5°C ~ 30°C	Below 60%RH

After opened and not in factory original sealed bag package

TEMPERATURE CONDITION	HUMIDITY CONDITION	STORAGE TIME
5°C ~ 30°C	Below 60%RH	Within 4 weeks (MSL as level 2a)

Tape & Reel Dimensions



1350PCS / 1 REEL

Dimensions in millimeters

Compliance and Approvals

